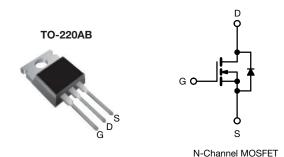
Vishay Siliconix

COMPLIANT

HALOGEN

FREE

E Series Power MOSFET



| PRODUCT SUMMARY | | | | |
|--|-------------------------|-------|--|--|
| V _{DS} (V) at T _J max. | 700 | | | |
| R _{DS(on)} typ. (Ω) at 25 °C | $V_{GS} = 10 \text{ V}$ | 0.087 | | |
| Q _g max. (nC) | 62 | | | |
| Q _{gs} (nC) | 16 | | | |
| Q _{gd} (nC) | 15 | | | |
| Configuration | Single | | | |

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- · Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

| ORDERING INFORMATION | | | |
|---------------------------------|-----------------|--|--|
| Package | TO-220AB | | |
| Lead (Pb)-free and halogen-free | SiHP100N65E-GE3 | | |

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | | |
|--|---|-----------------------------------|-------------|------|--|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | | |
| Drain-source voltage | | V_{DS} | 650 | V | | |
| Gate-source voltage | V_{GS} | ± 30 |] | | | |
| Continuous drain current (T _J = 150 °C) | V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$ | - I _D | 30 | A | | |
| | V_{GS} at 10 V_{C} $T_{C} = 100 ^{\circ}C$ | | 19 | | | |
| Pulsed drain current ^a | I _{DM} | 63 | | | | |
| Linear derating factor | | | 1.47 | W/°C | | |
| Single pulse avalanche energy b | | E _{AS} | 127 | mJ | | |
| Maximum power dissipation | | P_{D} | 208 | W | | |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +150 | °C | | |
| Drain-source voltage slope | | dv/dt | 100 | V/ns | | |
| Reverse diode dv/dt ^c | | | 11 | | | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,$ I_{AS} = 3.0 A
- c. $I_{SD} \leq I_D$, di/dt = 100 A/ μ s, starting T_J = 25 °C



Vishay Siliconix

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------------|-------------------|------|------|-------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum junction-to-ambient | R _{thJA} | - | 62 | °C/W | |
| Maximum junction-to-case (drain) | R _{thJC} | - | 0.6 | C/ VV | |

| PARAMETER | SYMBOL | TES | TEST CONDITIONS | | TYP. | MAX. | UNIT |
|---|-----------------------|---|---|-----|-------|-------|------|
| Static | | | | | | | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 650 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | Reference to 25 °C, I _D = 1 mA | | 0.68 | - | V/°C |
| Gate-source threshold voltage (N) | V _{GS(th)} | V _{DS} = | · V _{GS} , I _D = 250 μA | 3.0 | - | 5.0 | V |
| Gate-source leakage | I _{GSS} | $V_{GS} = \pm 20 \text{ V}$ | | - | - | ± 100 | nA |
| | | , | $V_{GS} = \pm 30 \text{ V}$ | - | - | ± 1 | μΑ |
| | | V _{DS} = | $V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$ | | - | 1 | μΑ |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = 520 V | V _{DS} = 520 V, V _{GS} = 0 V, T _J = 125 °C | | - | 10 | |
| Drain-source on-state resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 12 A | - | 0.087 | 0.100 | Ω |
| Forward transconductance ^a | 9 _{fs} | V _{DS} | = 8 V, I _D = 14 A | - | 12 | - | S |
| Dynamic | | | | | | | |
| Input capacitance | C _{iss} | | $V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ | | 2137 | - | pF |
| Output capacitance | C _{oss} | , | | | 89 | - | |
| Reverse transfer capacitance | C _{rss} | f = 1 MHz | | - | 2 | - | |
| Effective output capacitance, energy related ^a | C _{o(er)} | | | - | 90 | - | |
| Effective output capacitance, time related ^b | $C_{o(tr)}$ | $V_{DS} = 0$ | $V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$ | | 633 | - | |
| Total gate charge | Qg | | V _{GS} = 10 V | - | 41 | 62 | nC |
| Gate-source charge | Q _{gs} | V _{GS} = 10 V | | - | 16 | - | |
| Gate-drain charge | Q _{gd} | | | - | 15 | - | |
| Turn-on delay time | t _{d(on)} | | V _{DD} = 520 V, I _D = 14 A, | | 28 | 56 | |
| Rise time | t _r | V _{DD} = | | | 68 | 136 | |
| Turn-off delay time | t _{d(off)} | | $= 10 \text{ V}, R_g = 9.1 \Omega$ | - | 50 | 100 | ns |
| Fall time | t _f | 1 | | - | 32 | 64 | 1 |
| Gate input resistance | R_g | f = 1 MHz, Open Drain | | 0.5 | 1.1 | 2.2 | Ω |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous source-drain diode current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 30 | |
| Pulsed diode forward current | I _{SM} | | | - | - | 63 | A |
| Diode forward voltage | V _{SD} | T _J = 25 °C, I _S = 14 A, V _{GS} = 0 V | | - | - | 1.2 | V |
| Reverse recovery time | t _{rr} | T _J = 25 °C, I _F = I _S = 14A, di/dt = 100 A/μs, V _R = 25 V | | - | 362 | 724 | ns |
| Reverse recovery charge | Q _{rr} | | | - | 5.0 | 10 | μC |
| Reverse recovery current | I _{RRM} | | | _ | 22 | - | Α |



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

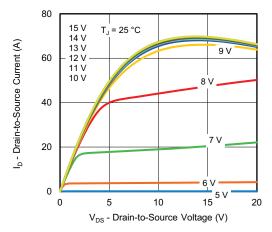


Fig. 1 - Typical Output Characteristics

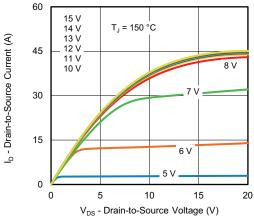


Fig. 2 - Typical Output Characteristics

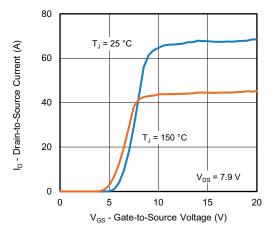


Fig. 3 - Typical Transfer Characteristics

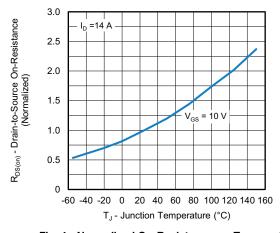


Fig. 4 - Normalized On-Resistance vs. Temperature

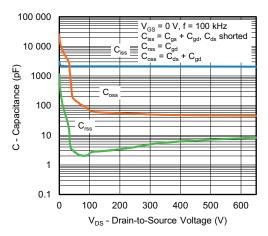


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

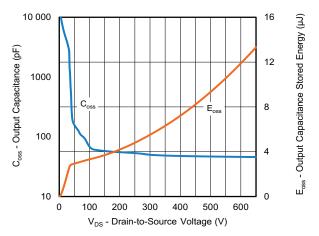


Fig. 6 - Coss and Eoss vs. VDS



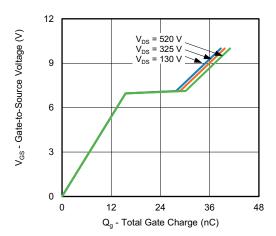


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

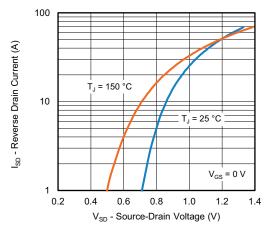


Fig. 8 - Typical Source-Drain Diode Forward Voltage

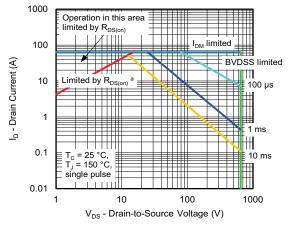


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

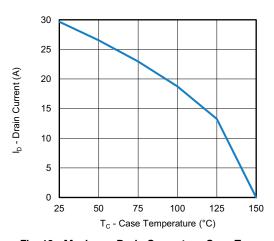


Fig. 10 - Maximum Drain Current vs. Case Temperature

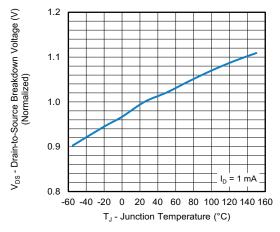


Fig. 11 - Temperature vs. Drain-to-Source Voltage



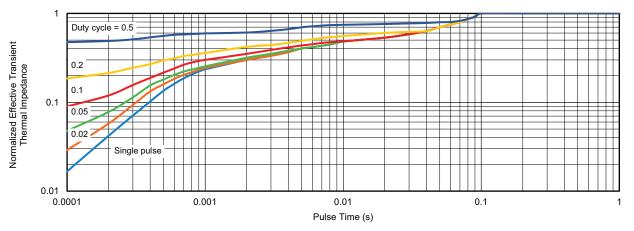


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

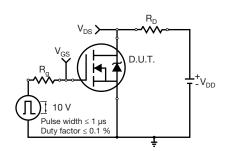


Fig. 13 - Switching Time Test Circuit

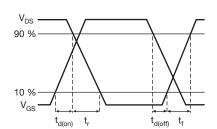


Fig. 14 - Switching Time Waveforms

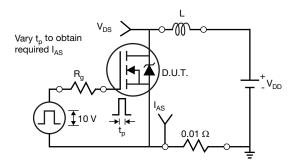


Fig. 15 - Unclamped Inductive Test Circuit

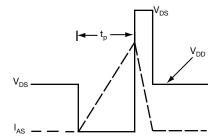


Fig. 16 - Unclamped Inductive Waveforms

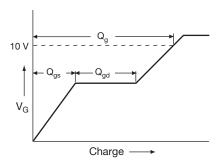


Fig. 17 - Basic Gate Charge Waveform

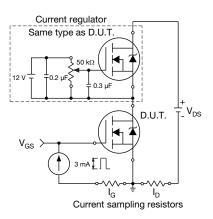
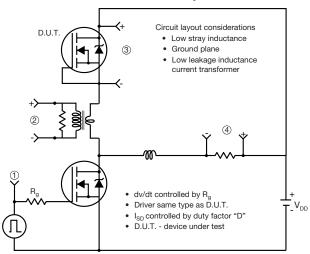


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



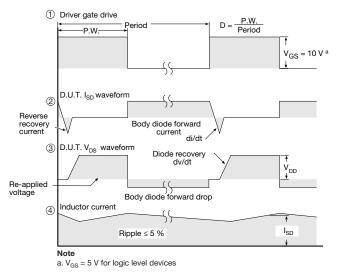


Fig. 19 - For N-Channel

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